

RoHS Compliant Product
A suffix of "-C" specifies halogen & lead-free

FEATURES

- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Epitaxial Construction

MECHANICAL DATA

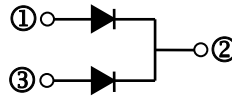
- Case: Molded Plastic
- Epoxy: UL 94V-0 Rate Flame Retardant
- Lead: Lead Solderable per MIL-STD-202 Method 208 Guaranteed
- Polarity: As Marked
- Mounting Position: Any

PACKAGE INFORMATION

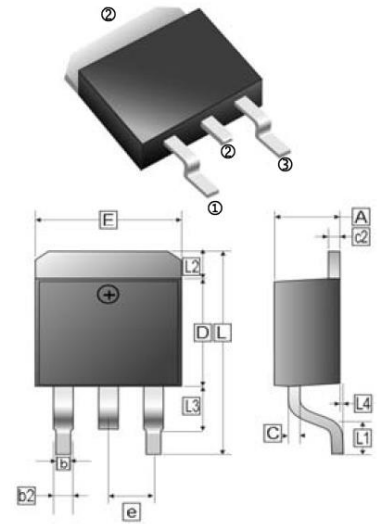
Package	MPQ	Leader Size
TO-263	0.8K	13 inch

ORDER INFORMATION

Part Number	Type
SM2020D	Lead (Pb)-free
SM2020D-C	Lead (Pb)-free and Halogen-free



TO-263(D²-PACK)



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.00	4.87	c2	1.07	1.65
b	0.51	1.01	b2	1.34	REF
L4	0.00	0.30	D	8.0	9.65
C	0.30	0.74	e	2.54	REF
L3	1.50	REF	L	14.6	16.1
L1	2.5	REF	L2	1.27	REF
E	9.60	10.67			

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, de-rate current by 20%.)

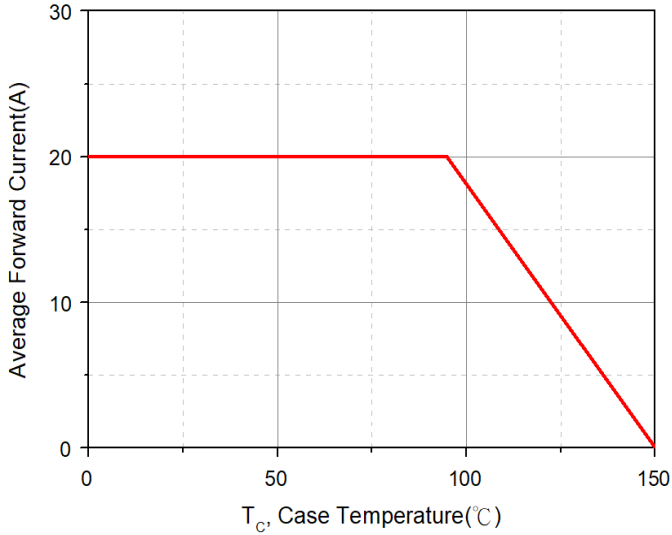
Parameter	Symbol	Rating	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	200	V
Maximum RMS Voltage	V_{RMS}	140	V
Maximum DC Blocking Voltage	V_{DC}	200	V
Maximum Average Forward Rectified Current	I_F	Per Leg	10
		Per Device	20
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	180	A
Maximum Instantaneous Forward Voltage @10A Per Leg	V_F	$T_A=25^\circ\text{C}$	0.92
		$T_A=125^\circ\text{C}$	0.80
Maximum Reverse Current at Rated VR Per Diode ³	I_R	$T_A=25^\circ\text{C}$	0.01
		$T_A=125^\circ\text{C}$	5
Voltage Rate of Change	dv/dt	10000	V/us
Typical Junction Capacitance ¹	C_J	2400	pF
Typical Thermal Resistance from Junction-Case ²	$R_{\theta JC}$	6	°C/W
Operating & Storage Temperature Range	T_J, T_{STG}	-55~150	°C

Notes:

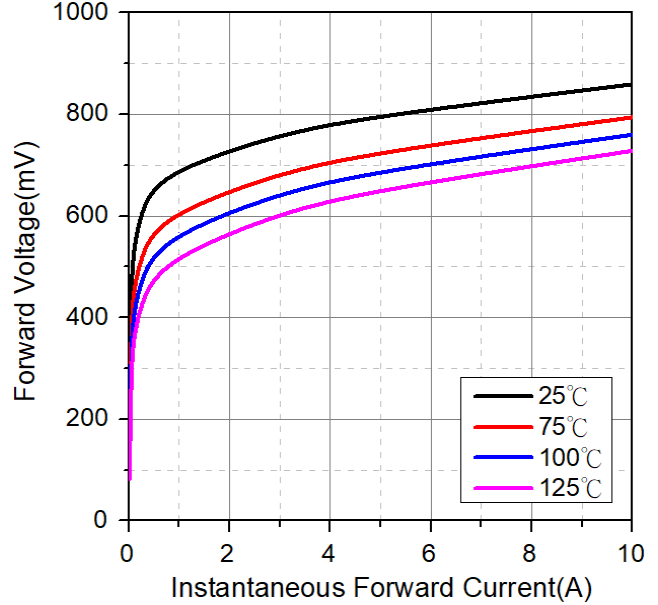
1. Measured at 1MHz and applied reverse voltage of 4V D.C.
2. FR-4 Board Heat sink size: 10*10*0.2mm.
3. Plus test: 300µs Pulse width, 1% duty cycle.

CHARACTERISTIC CURVES

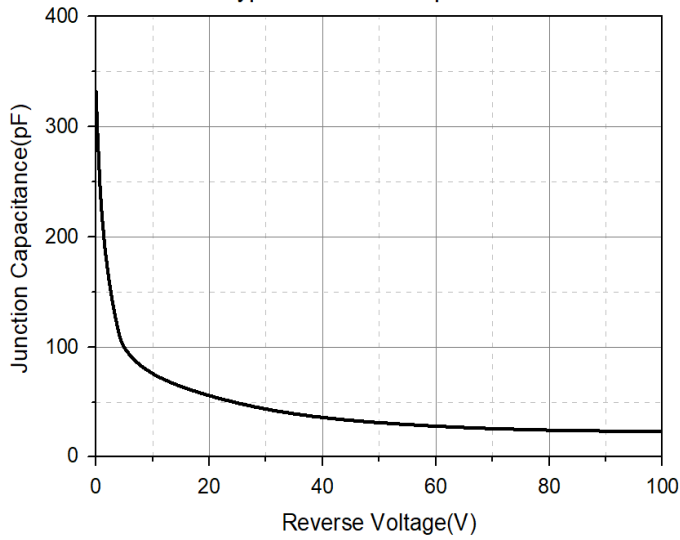
Typical Forward Current Derating Curve



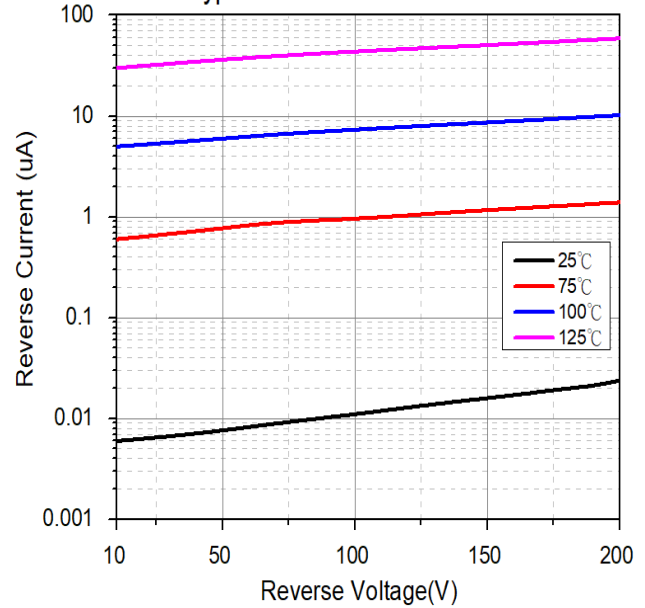
Typical Forward Characteristic



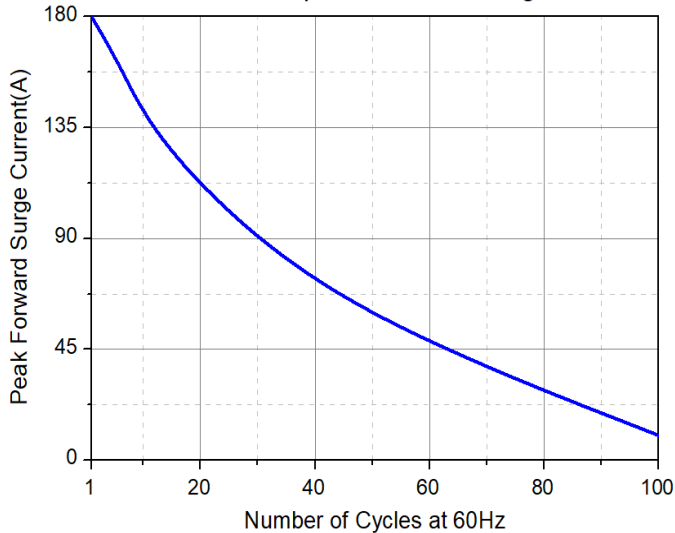
Typical Junction Capacitance



Typical Reverse Characteristic



Maximum Non-Repetitive Forward Surge Current



Mounting Pad Layout

